

Low-Dropout, Constant-Current White LED Bias Supply

#### **FEATURES**

- Up to 400mA LED Bias Current
- 3% LED Current Matching
- Simple LED Brightness Control
- Low 0.05uA Shutdown Current
- 2.7V to 5V Supply Voltage Range
- SOP-8 Package and Lead-free
- VSET Resistor Option :

T6316A: External Resistor

T6316B: 20, 85, 100, 125, 150, 175, 200, 250, 300 and 350mA Output Current Option by Internal Resistor

• Build in Thermat Protect 160 °C

# **Applications**

- Portable Communication Devices
- Handheld Electronics
- LED/Display Back Light Driver
- Lightings

#### GENERAL DESCRIPTION

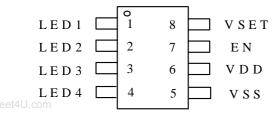
The T6316A/B low-dropout bias supply for white LEDs is a high-performance alternative to the simple ballast resistors used in conventional white LED designs. The T6316A uses a single resistor to set the bias current for four LEDs, which are matched to 3%. The T6316B build in internal resistor to set the bias current for four LED. The T6316A/B advantages over ballast resistors include significantly better LED to LED bias matching, much lower bias variation with supply voltage variation, significantly lower dropout voltage, in some applications, significantly improved efficiency. T6316A/B The available in SOP-8 package and lead-free.

#### PART NUMBER EXAMPLES

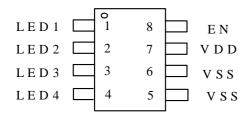
| PART NO.     | PACKAGE            | Output Vset Current resistor |          |  |
|--------------|--------------------|------------------------------|----------|--|
| T6316A-D     | SOP-8              | -                            | External |  |
| T6316A-DG    | SOP-8<br>lead-free | -                            | External |  |
| T6316B-20D   | SOP-8              | 20mA                         | Internal |  |
| T6316B-20DG  | SOP-8<br>lead-free | 20mA                         | Internal |  |
| T6316B-75D   | SOP-8              | 75mA                         | Internal |  |
| T6316B-75DG  | SOP-8<br>lead-free | 75mA                         | Internal |  |
|              |                    |                              |          |  |
|              |                    |                              |          |  |
| T6316B-350D  | SOP-8              | 350mA                        | Internal |  |
| T6316B-350DG | SOP-8<br>lead-free | 350mA                        | Internal |  |



# PIN ARRANGEMENT(Top view)



SOP-8 T6316A-D



SOP-8 T6316B-D

## PIN DESCRIPTION

| -      |        | ,      |  |  |  |
|--------|--------|--------|--|--|--|
| SYMBOL | T6316A | T6316B | DESCRIPTION  |  |  |
| LED1   | 1      | 1      | LED 1 Cathode Connection. Current flowing into LED1 is 270/250 times the current flowing into SET. LED1 is high impedance when EN is low.  |  |  |
| LED2   | 2      | 2      | LED 2 Cathode Connection. Current flowing into LED1 is 270/250 times the current flowing into SET. LED2 is high impedance when EN is low.  |  |  |
| LED3   | 3      | 3      | LED 3 Cathode Connection. Current flowing into LED1 is 270/250 times the current flowing into SET. LED3 is high impedance when EN is low.  |  |  |
| LED4   | 4      | 4      | LED 4 Cathode Connection. Current flowing into LED1 is 270/250 times the current flowing into SET. LED4 is high impedance when EN is low.  |  |  |
| VSS    | 5      | 5,6    | Ground   |  |  |
| VDD    | 6      | 7      | Power supply   |  |  |
| EN     | 7      | 8      | Enables PN6316A/B signal, H: Ative, L: Power Down.   |  |  |
| VSET   | 8      | -      | VSET terminal is used to connect an external resistor to set output current.  The current flowing into VSET sets the bias current into each LED by ILED_= 250 x ISET.  VSET is internally biased to 0.306V. VSET is high impedance when EN is low. |  |  |



## **ABSOLUTE MAXIMUM RATINGS**

| Parameter   | Symbol            | Value       | Unit |
|---|-------------------|-------------|------|
| Voltage on any pin relative to GND                    | V <sub>IN</sub>   | -0.3 to 6   | V    |
| Operating Temperature Rang                            | T <sub>A</sub>    | -40 to +85  | °C   |
| Maximum Soldering Temperature (at leads, 10 sec)      | T <sub>LEAD</sub> | 300         | °C   |
| Storage Temperature Rang                              | $T_{S}$           | -65 to +150 | °C   |
| Continuous Power Dissipation ( $T_A = +70^{\circ}C$ ) |                   | 1           | W    |

## **Electrical Characteristics**

 $(TA = -40 \text{ to } 85^{\circ}\text{C} \text{ unless otherwise noted.}$  Typical values are at TA = 25°C,

VEN =3.3V, VLED1 = VLED2= VLED3= VLED4= 1V)

| Symbol          | Description                     | Conditions   | Min.   | Typ. | Max   | Unit |     |
|-----------------|---------------------------------|--|--------|------|-------|------|-----|
| VEN             | Operating voltage range         | EN is power supply input   |        |      |       | 5    | V   |
| ISET            | SET input current range         |  |        |      | 1400  | 1600 | uA  |
| Isetr           | SET to LED current ratio        | ILED / ISET, ISET=400uA  | T6316A |      | 270   |      | A/A |
|                 |                                 |  | T6316B |      | 250   |      |     |
| VSET            | SET bias voltage                | Iset=400uA, no loading   |        |      | 0.306 |      | V   |
| Icm             | LED to LED current matching     | Iset=400uA, 100mA loading  |        |      | 3     |      | %   |
| ILED            | Maximum LED sink current        | Each LED   |        |      | 350   | 400  | mA  |
| Ilsd            | LED leakage current in shutdown | VLED1=VLED2=VLED3=VLI<br>EN=GND, Ta=+25°C, each  | ,      |      | 0.01  | 1    | uA  |
| VIH             | Input high voltage              | VEN >VIH for enable, VDD=5V  |        | 2.0  |       |      | V   |
| V <sub>IL</sub> | Input low voltage               | VEN <vil disable,="" for="" vdd="5V&lt;/td"><td></td><td></td><td>0.8</td><td>V</td></vil> |        |      |       | 0.8  | V   |
| Ттр             | Thermat Protect                 |  |        |      | 160   |      | °C  |

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## **Functional Description**

The T6316A/B provides constant current bias supply for white LED designs. The T6316A uses a single resistor to set the bias current for up to four LEDs. LED bias currents are matched to 3%. The T6316B build in internal resistor to set the bias current for four LED. The T6316A/B offers several advantages over using ballast resistors, such as improved LED to LED brightness matching, lower bias variation with supply voltage changes, significantly lower dropout voltage. and in some applications, significantly improved efficiency.

### **Enable Input**

EN powers the input of the T6316A/B. Drive EN high (> 2.0V) to enable the device; drive EN low (< 0.8V) to disable the device. Driving EN low forces LED1, LED2, LED3, LED4 and SET into a high-impedance state.

### **Setting the Output Current**

SET controls the LED bias current. Current flowing into LED1, LED2, LED3 and LED4 is 270/250 times greater than the current flowing

into SET. Set the output current as follows:

#### T6316A

ILED = 270 (0.306 V / Rset)

#### T6316B

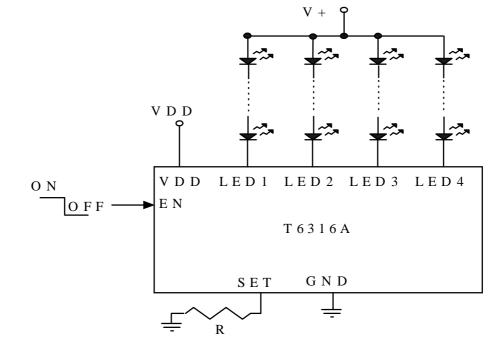
ILED = 250 (0.306 V / RSET)

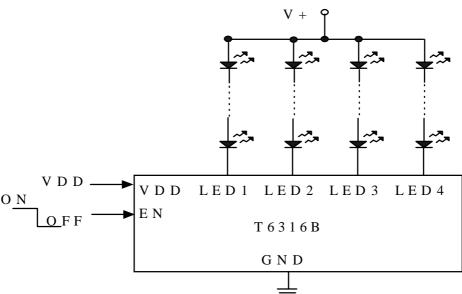
## **Applications Information**

Very Low-Cost, High-Efficiency Solution . A battery (single Li+ or three NiMH cells) powers the LEDs directly. This is the least expensive and most efficient architecture. Due to the high forward voltage of white LEDs, the LED brightness may dim slightly at the end of battery life. The T6316A/B current regulating architecture and low dropout greatly minimize this effect compared to using simple ballast resistors. The enable function of the T6316A/B turns on and off the LEDs.



# TYPICAL APPLICATION CIRCUITS



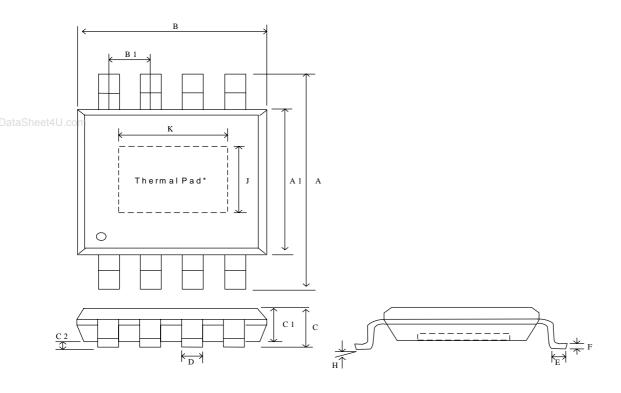


Very low-cost, high-efficiency solution

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## PACKAGE DIMENSIONS 8-LEAD SOP



| Symbol | Dimension in mm |          |      | Dimension in inch |           |       |  |
|--------|-----------------|----------|------|-------------------|-----------|-------|--|
|        | Min.            | Тур.     | Max. | Min.              | Typ.      | Max.  |  |
| A      | 5.70            | 6.00     | 6.30 | 0.224             | 0.236     | 0.248 |  |
| A1     | 3.75            | 3.95     | 4.10 | 0.148             | 0.156     | 0.164 |  |
| В      | =               | ı        | 5.13 | ı                 | -         | 0.202 |  |
| B1     | -               | 1.27     | -    | -                 | 0.050     | -     |  |
| C      | -               | -        | 1.80 | -                 | -         | 0.071 |  |
| C1     | 1.35            | 1.55     | 1.75 | 0.052             | 0.061     | 0.069 |  |
| C2     | 0.10            | ı        | 0.25 | 0.001             | -         | 0.004 |  |
| D      | 0.31            | 0.41     | 0.51 | 0.012             | 0.016     | 0.020 |  |
| Е      | 0.30            | 0.50     | 0.70 | 0.012             | 0.020     | 0.028 |  |
| F      | 0.10            | 0.15     | 0.25 | 0.004             | 0.006     | 0.010 |  |
| J      |                 | 2.23 REF |      |                   | 0.088 REF |       |  |
| K      |                 | 2.97 REF |      |                   | 0.117 REF |       |  |
| Н      |                 | 0~8°     |      |                   | 0~8°      |       |  |

#### \*Note:

The thermal pad on the IC's bottom has to be mounted on the copper foil.

To eliminate the noise influence, the thermal pad is suggested to be connected to GND on PCB. In addition, desired thermal conductivity will be improved, if a heat-conducting copper foil on PCB is soldered with thermal pad. The thermal pad enhances the power dissipation. As a result, a large amount of current can be sunk safely in one package.